MODULE WIREBONDING (one technician)

Preparation (1min):

- Get module from cabinet
- Take module out of box
- Mount module on wire bonding fixture
- Scan barcode and start database
- Drive fixture in

Bonding (10min 10sec):

- Do 5 bonds on P.A. test area (45 sec)
- Do bias bonds (2 min)
- Check number of bonds made thus far and enter into database (15)
- Start bonding program and bond all signal wires (4min 30sec to 5min, depending on eyepoints and whether it's a 4- or 6-chip module
- Check that all bonds are there, if not, re-do missing bonds (2min)
- Remove module from wire bonding fixture (10 sec)

Post-bonding tasks (6min 55sec):

- Put module under stereoscope and check bonds (30sec)
- Get bad channel list from database (30sec)
- Pluck bad channels (1min 40sec)
- Put module on pull tester and pull test P.A. test area bonds (1min 45sec)
- Put module back into box and return to cabinet (30sec)
- Enter pull test results and all other information into database (2min)

Total time: 18min 5sec

MODULE WIREBONDING(with two technicians)

First Technician:

Preparation (20sec):

- Get module from cabinet
- Take module out of box and give to second technician

Second Technician:

Preparation (25sec):

- Mount module on wire bonding fixture
- Drive fixture in

Bonding (10min 20sec):

- Do 5 bonds on P.A. test area (45 sec)
- Do bias bonds (2 min)
- Check number of bonds made thus far and write it down (15sec)
- Start bonding program and bond all signal wires (4min 30sec to 5min, depending on eyepoints and whether it's a 4- or 6-chip module
- Check that all bonds are there, if not, re-do missing bonds (2min)
- Remove module from wire bonding fixture (10 sec)
- Give module back to first technician (10sec)

First Technician:

Post-bonding tasks (7min 20sec):

- Get module from second technician (10sec)
- Put module under stereoscope and check bonds (30sec)
- Open database and scan barcode (30sec)
- Get bad channel list from database (15sec)
- Pluck bad channels (1min 40sec)
- Put module on pull tester and pull test P.A. test area bonds (1min 45sec)
- Enter pull test results and all other information into database (2min)
- Put module back into box and return to cabinet (30sec)

Total time: 10min 45sec